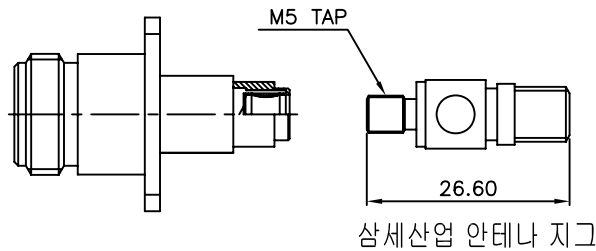
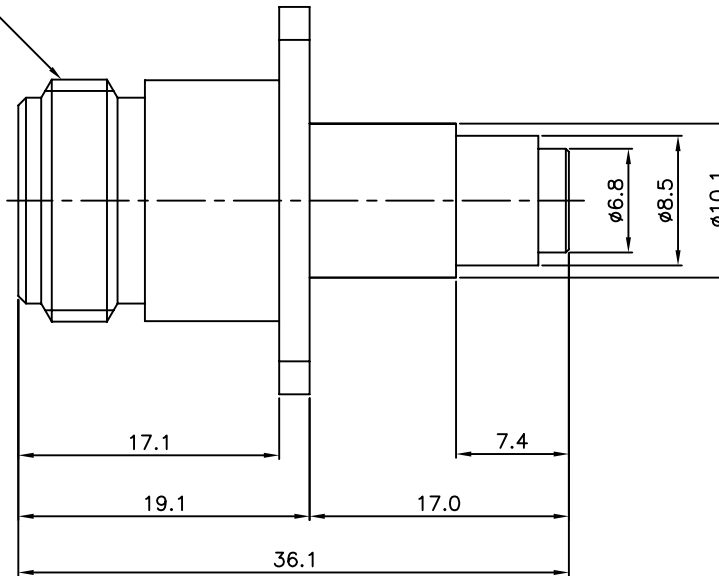
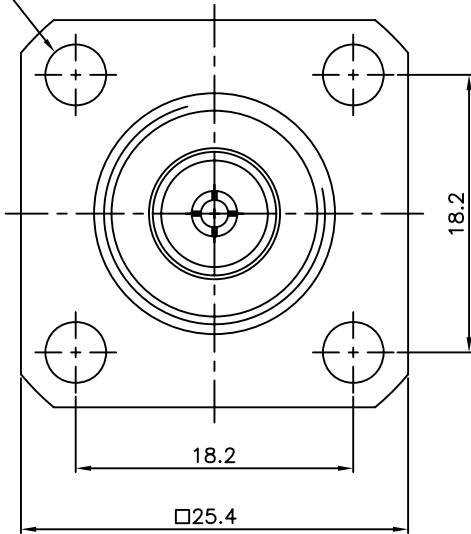


REVISION				
REV	DESCRIPTION	DRAWN	APPR	DATE
IR	Initial Registration	E.H.KIM	I.C.KIM	2013.01.28.
1	[설번처리No.201304-0008] 업체요청 (홀 사이즈 변경)	E.H.KIM	I.C.KIM	2013.04.26.
2	[설번처리No.202009-0005] 조립공차 ±0.1 -> ±0.2 변경	S.Y.EUN	I.C.KIM	2020.09.25.

구코드: CN02890-7/2

1
4-~~Ø3.2~~ THRU
4-Ø4.0 THRU

5/8-24 UNEF-2A



6	SPRING RING	1	BeCu	Gold Plate	DPS00001-5/1
5	CAP	1	MBsBD	Nickel Plate	DCU02199-5/1
4	INSULATOR	1	TEFLON		DIN02117-N/1
3	CONTACT	1	MBsBD	Gold Plate	DCT02759-5/1
2	CONTACT	1	BeCu	Gold Plate	DCT00693-5/2
1	BODY	1	MBsBD	Nickel Plate	DBD03323-5/1
NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE

		1		BODY		1		MBsBD		Nickel Plate		DBD03323-5/1 DBD03190-5/1			
		2		NO.		DESCRIPTION		Q'TY		MATERIAL		PLATING		CODE	
TOLERANCE		Decimal		DATE					 KJ COMTECH CO.,LTD.		RF & MICROWAVE TECHNOLOGY Tel : 82-32-347-8015 Fax : 82-32-347-8017				
		±0.2		2020. 09. 25.											
		Angle		APPROVED BY		I.C.KIM									
MATERIAL		±1°		CHECKED BY							TITLE N50 SOLDER END JS-4H ANTENNA JIG용 (M5안테나용)				
				DRAWN BY		S.Y.EUN									
FINISH		SCALE 2/1		UNIT mm				A4		DWG NO.		AD00677-7/1			
										REVISION		2		SHEET	